



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

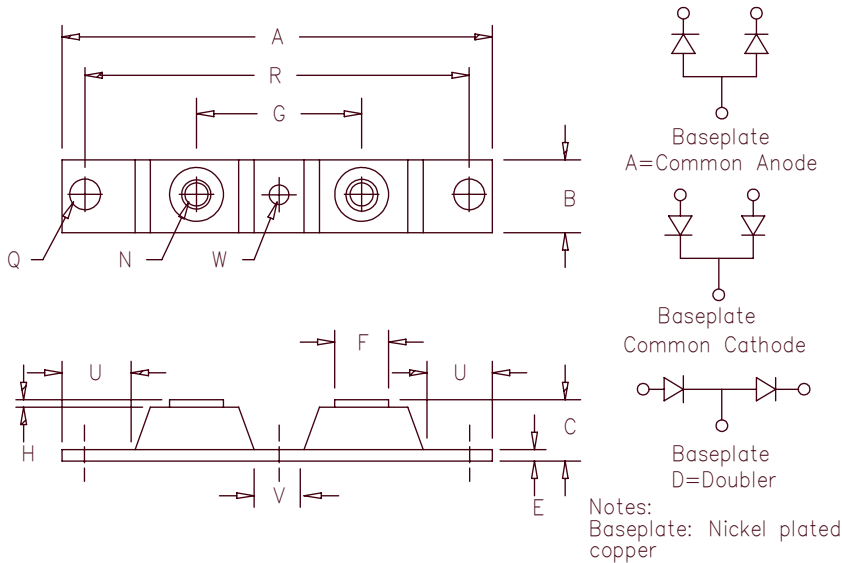
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# Schottky PowerMod

## CPT30035 — CPT30050



Dim.	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	---	3.630	---	92.20	
B	0.700	0.800	17.78	20.32	
C	---	0.630	---	16.00	
E	0.120	0.130	3.05	3.30	
F	0.490	0.510	12.45	12.95	
G	1.375 BSC		34.92 BSC		
H	0.010	---	0.25	---	
N	---	---	---	---	1/4-20
Q	0.275	0.290	6.99	7.37	Dia.
R	3.150 BSC		80.01 BSC		
U	0.600	---	15.24	---	
V	0.312	0.340	7.92	8.64	
W	0.180	0.195	4.57	4.95	Dia.

Microsemi Catalog Number	Industry Part Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
CPT30035*	301CNQ035	35V	35V
CPT30040*	301CNQ040	40V	40V
CPT30045*	301CNQ045	45V	45V
	MBRP30045CT		
CPT30050*		50V	50V

\*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 300 Amperes/35 to 50 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

### Electrical Characteristics

Average forward current per pkg	$I_{F(AV)}$ 300 Amps	$T_C = 136^\circ\text{C}$ , Square wave, $R_{\theta JC} = 0.20^\circ\text{C/W}$
Average forward current per leg	$I_{F(AV)}$ 150 Amps	$T_C = 136^\circ\text{C}$ , Square wave, $R_{\theta JC} = 0.40^\circ\text{C/W}$
Maximum surge current per leg	$I_{FSM}$ 2000 Amps	8.3ms, half sine, $T_J = 175^\circ\text{C}$
Maximum repetitive reverse current per leg	$I_{R(OV)}$ 2 Amps	$f = 1 \text{ KHZ}$ , $25^\circ\text{C}$
Max peak forward voltage per leg	$V_{FM}$ 0.70 Volts	$I_{FM} = 200\text{A}$ ; $T_J = 125^\circ\text{C}$ *
Max peak forward voltage per leg	$V_{FM}$ 0.76 Volts	$I_{FM} = 200\text{A}$ ; $T_J = 25^\circ\text{C}$ *
Max peak reverse current per leg	$I_{RM}$ 75 mA	$V_{RRM}$ , $T_J = 125^\circ\text{C}$ *
Max peak reverse current per leg	$I_{RM}$ 4.0 mA	$V_{RRM}$ , $T_J = 25^\circ\text{C}$
Typical junction capacitance per leg	$C_J$ 4600 pF	$V_R = 5.0\text{V}$ , $T_C = 25^\circ\text{C}$

\*Pulse test: Pulse width 300 $\mu$ sec, Duty cycle 2%

### Thermal and Mechanical Characteristics

Storage temp range	$T_{STG}$	-55°C to 175°C
Operating junction temp range	$T_J$	-55°C to 175°C
Max thermal resistance per leg	$R_{\theta JC}$	0.40°C/W Junction to case
Max thermal resistance per pkg	$R_{\theta JC}$	0.20°C/W Junction to case
Typical thermal resistance (greased)	$R_{\theta CS}$	0.08°C/W Case to sink
Terminal Torque		35-40 inch pounds
Mounting Base Torque (outside holes)		30-40 inch pounds
Mounting Base Torque (center hole)		8-10 inch pounds
center hole must be torqued first		
Weight		2.8 ounces (75 grams) typical

# CPT30035 — CPT30050

Figure 1  
Typical Forward Characteristics — Per Leg

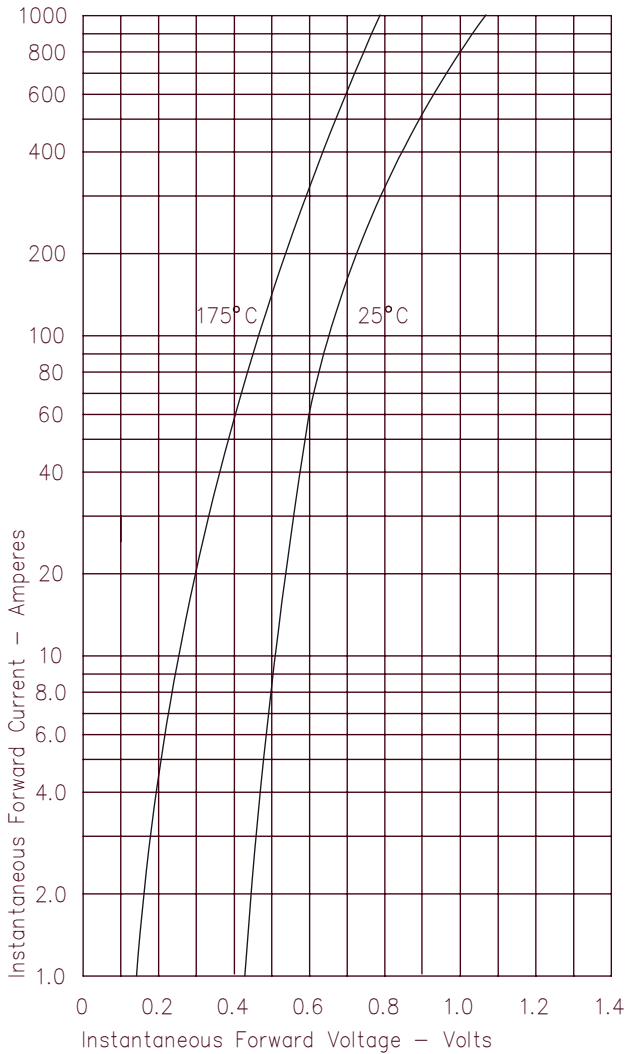


Figure 3  
Typical Junction Capacitance — Per Leg

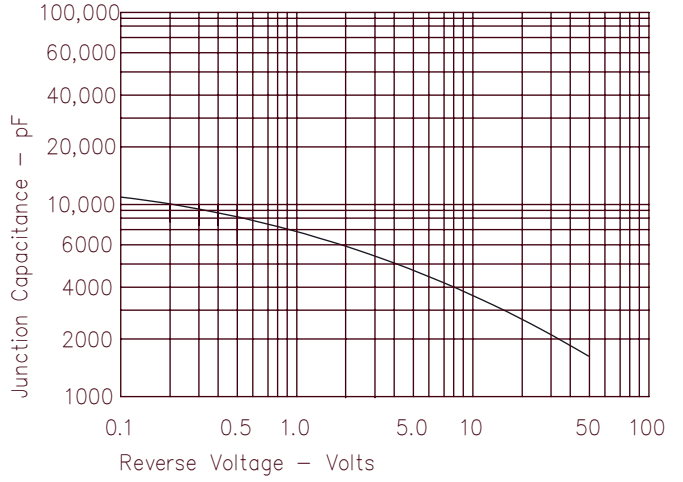


Figure 4  
Forward Current Derating — Per Leg

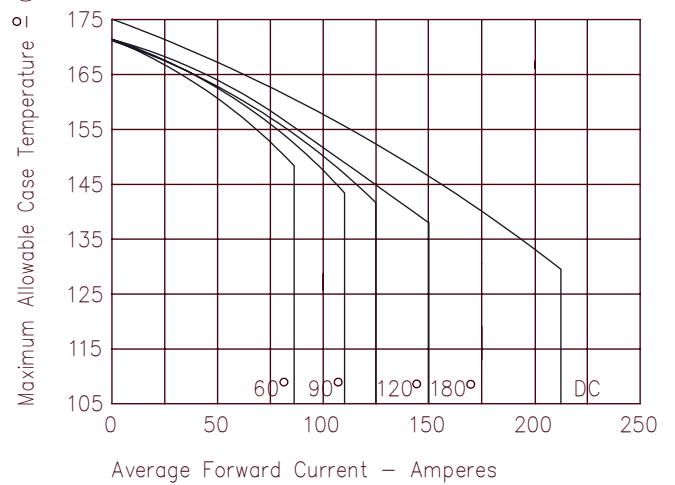


Figure 2  
Typical Reverse Characteristics — Per Leg

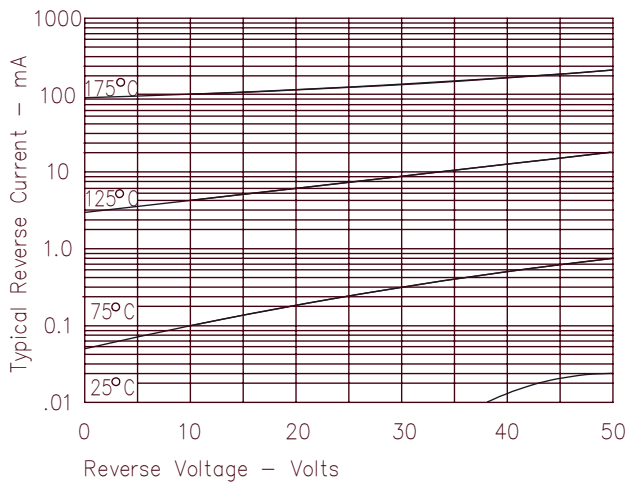
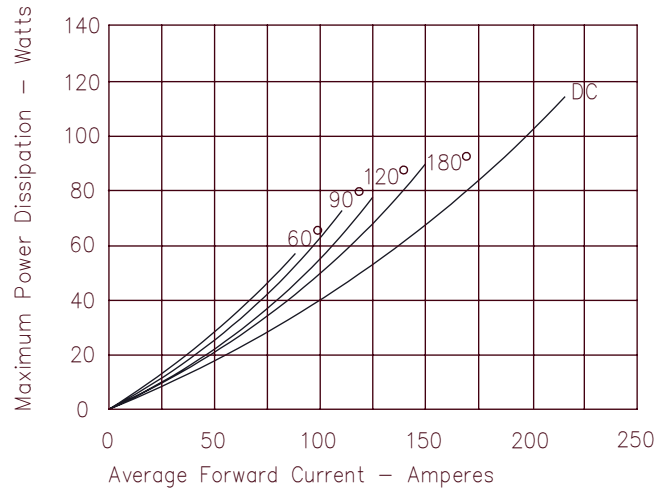


Figure 5  
Maximum Forward Power Dissipation — Per Leg



## DISCLAIMER

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customers final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at <http://www.microsemi.com/legal/tnc.asp>

### Life Support Application

Seller's Products are not designed, intended, or authorized for use as components in systems intended for space, aviation, surgical implant into the body, in other applications intended to support or sustain life, or for any other application in which the failure of the Seller's Product could create a situation where personal injury, death or property damage or loss may occur (collectively "Life Support Applications").

Buyer agrees not to use Products in any Life Support Applications and to the extent it does it shall conduct extensive testing of the Product in such applications and further agrees to indemnify and hold Seller, and its officers, employees, subsidiaries, affiliates, agents, sales representatives and distributors harmless against all claims, costs, damages and expenses, and attorneys' fees and costs arising, directly or indirectly, out of any claims of personal injury, death, damage or otherwise associated with the use of the goods in Life Support Applications, even if such claim includes allegations that Seller was negligent regarding the design or manufacture of the goods.

Buyer must notify Seller in writing before using Seller's Products in Life Support Applications. Seller will study with Buyer alternative solutions to meet Buyer application specification based on Sellers sales conditions applicable for the new proposed specific part.

---